| ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Par | PC. Bannockl | burn, Illinois, A | Il rights reserved untions. | under both | This docume level parts, t | ent is a declarati he declaration e | on of the su | ibstances v s all lower | within the manufactule level materials for w | urer listed which the | item. Note: manufacture | if the item is an as er has engineering | sembly with low responsibility. | |
|--|--------------------------------|-----------------------------|-----------------------------|---|-------------------------------|--|---|----------------------------|--|-------------------------|---------------------------------|--|---------------------------------|--|
| IPC Web Site for Information on IPC-1752 Standard Fo | | | Form Type Distribute | e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater | | | | rials and N | als and Mfg Information | | | | | |
| Supplier Information | | | | | | | | | | | | | | |
| Company name* Compa | | | ompany unique ID | | | Unique ID Authority | | | | Respon | Response Date* | | | |
| onsemi | | | | | | | | | | | 2025-06-03 | | | |
| ntact Name Title - Contact | | | ct | | Phone - Contact* | | | Email - Contact* | | | | | | |
| Product-Env-Stewards Product Env | | | nviro Compliance | | | NA | | | | Produ | Product-Env-Stewards@onsemi.com | | | |
| Authorized Representative* Title - Representative | | | resentative | | | Phone - Representative* | | | Email | Email - Representative* | | | | |
| Product-Env-Stewards Pro- | | | Product Enviro Compliance | | | NA | | | | Produ | Product-Env-Stewards@onsemi.com | | | |
| Requester Item Number | Requester Item Number Mfr Item | | n Number Mfr Item Name | | | Effective Date | Version | on Manufacturing Site | | | Weight* | UOM | Unit Type | |
| | SZMMS | SZMMSZ4694T3G ZEN SOD123 RE | | EG 0.5W 8.2V | | 2025-06-03 | | C | CN1 | | 11.67 | mg | Each | |
| Ianufacturing Proccess Informa | tion | | | | | | | | | | | | | |
| Terminal Plating / Grid Array M | aterial | ial Terminal Base Alloy | | J-STD-020 MSI | L Rating | Peak Proce | Process Body Temperature Max Time at Peak | | k Tempera | ture Num | ber of Reflow Cyc | eles | | |
| Matte Tin (Sn) - annealed CU Alloy | | CU Alloy | | 1 | | 260 | | С | 30 | seco | nds 3 | | | |
| omments | | | | | | | | | | | | | | |
| vel 1 - maximum time at peak temperatu | ure during so | Idering is 10-3 | 0 seconds | | | | | | | | | | | |
| or more information regarding material | composition | please refer to | page 3 | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | |
|--|--|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | | nium (Cr6+), Polybro | ominated Biphenyls (PBB), Polybron | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | on above | Supplier Acceptance | * Accepted | | | | | | |
| Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. | | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | |
| Declaration Signature | | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| sigma range of distribution unless otherwise noted). | | | | | | | | | |
|--|--------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|--|
| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure | |
| Die | 0.88 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.88 | mg | |
| Lead Frame | 3.19 | mg | В | Nickel (Ni) | 7440-02-0 | | 1.158 | mg | |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 1.6014 | mg | |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.4306 | mg | |
| Mold Compound-Black | 6.51 | mg | Supplier | Ortho Cresol Novolac Resin | 29690-82-2 | | 0.651 | mg | |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.0325 | mg | |
| | | | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 | | 0.9439 | mg | |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 4.2315 | mg | |
| | | | Supplier | Phenolic Resin (Novolac) | 9003-35-4 | | 0.651 | mg | |
| Plating | 0.8 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 0.8 | mg | |
| Wire Bond | 0.29 | mg | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0038 | mg | |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.2862 | mg | |